**Components marked 'DNP' should not be populated.**

**Assembly Variant: 001**

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<th>PCB Viewed from Top Side</th>
<th>Board #: TIDA-00796</th>
<th>Rev: E2</th>
<th>Sun Rev: Not In VersionControl</th>
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**Plot Name:** Top Assembly Drawing  
**Generated:** 18-Mar-16 10:02:33 AM  
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